

Fair-Rite P/N **2744555567**

44 Material Grade

Nominal Chemical Composition

<u>Compound</u>	<u>CAS Number</u>	<u>wt %</u>	Wt of core (g)= 0.960	
Fe2O3	1309-37-1	63.97	0.6141	Compound Weight (g) Breakdown of 44 Material
ZnO	1314-13-2	21.00	0.2016	
NiO	1313-99-1	11.00	0.1056	
CuO	1317-38-0	4.00	0.0384	
Bi2O3	1304-76-3	0.03	0.0003	

Pb-Free Plated Round Cu Wire

<u>Element</u>	<u>CAS Number</u>	<u>wt%</u>	Wt of wire (g)= 0.109	
Cu	7440-50-8	94.4	0.10290	Element Weight (g) Breakdown of Pb- Free Plated Round Cu Wire
Plating:				
Ni	7440-02-0	0.9	0.00098	
Sn	7440-31-5	4.7	0.00512	

Calculated Maximum Levels of RoHS Restricted Substances Present in 44 Material Grade

<u>Impurity Substance</u>	<u>RoHS Threshold (ppm)</u>	<u>ppm</u>	Wt of core (g)= 0.960	
Cr+6	1000	0.00	0	RoHS Impurity Substance Weight (g) Breakdown of 44 Material
Cd	100	6.09	5.8464E-06	
Hg	1000	0.09	8.64E-08	
Pb	1000	10.90	0.000010464	
PBB	1000	0.00	0	
PBDE	1000	0.00	0	

Supporting notes:

1. P/N 2744555567 consists of:
 - a core 44 Material Grade
 - b wire Pb-Free Plated Round Cu Wire
2. Moisture Sensitivity Level (MSL)= 1
3. Max Reflow Temp= 260 degC
4. Max Time at Max Reflow Temp= 40 sec
5. RoHS 6/6 Compliant Terminations/ Wire are backwards compatible with standard Soldering Processes
6. RoHS Conversion Date= 1/1/2005
7. RoHS Compliance Marking is Contained on Shipping Labels